

## DESCRIPTION

These transistors are designed for general purpose amplifier applications. They are housed in the SC–88 which is designed for low power surface mount applications.

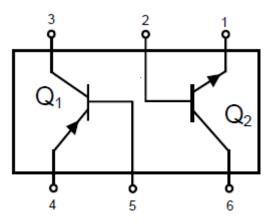
We declare that the material of product compliance with RoHS requirements.

The BC846BPDW~BC848CPDW is available in SC-88 Package

# FEATURES

• Available in SC–88 Package

## PIN DESCRIPTION



ORDERING INFORMATION

Package Type	Part Number				
SC88	BC846BPDW				
	BC847BPDW				
	BC847CPDW				
	BC848BPDW				
	BC848CPDW				
Note	SPQ: 3,000pcs/Reel				
AiT provides all RoHS Compliant Products					

- 1. EMITTER 2
- 2. BASE 2
- 3. COLLECTOR 1
- 4. EMITTER 1
- 5. BASE 1
- 6. COLLECTOR 2



### ABSOLUTE MAXIMUM RATINGS

#### MAXIMUM RATINGS-NPN

Parameter	Symbol	BC846	BC847	BC848	Unit
Collector-Emitter Voltage	V <sub>CEO</sub>	65	45	30	V
Collector-Base Voltage	Vсво	80	50	30	V
Emitter-Base Voltage	V <sub>EBO</sub>	6.0	6.0	5.0	V
Collector Current Đ Continuous	lc	100	100	100	mAdc

Stresses above may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated in the Electrical Characteristics are not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

#### **MAXIMUM RATINGS - PNP**

Parameter	Symbol	BC846	BC847	BC848	Unit
Collector-Emitter Voltage	VCEO	-65	-45	-30	V
Collector-Base Voltage	Vсво	-80	-50	-30	V
Emitter-Base Voltage	V <sub>EBO</sub>	-5.0	-5.0	-5.0	V
Collector Current Đ Continuous	lc	-100	-100	-100	mAdc

# THERMAL CHARACTERISTICS

Parameter	Symbol	Мах	Unit
Total Device Dissipation		380	mW
Per Device FR-5 Board <sup>NOTE1</sup>	D	250	
$T_A = 25^{\circ}C$	PD		
Derate Above 25°C		3.0	mW/°C
Thermal Resistance, Junction to Ambient	$R_{ extsf{ heta}JA}$	328	°C/W
Junction and Storage Temperature Range	Tj, Tstg	-55~+150	°C

NOTE1: FR-5 = 1.0 x 0.75 x 0.062 in



# ELECTRICAL CHARACTERISTICS (NPN)

 $T_A$  = 25°C, unless otherwise noted

Parameter	Symbol	Conditions		Min.	Тур.	Max.	Unit	
OFF CHARACTERISTICS								
			BC846	65	-	-		
Collector–Emitter Breakdown	V <sub>(BR)CEO</sub>	Ic = 10mA	BC847	45	-	-	V	
Voltage			BC848	30	-	-		
Collector Emitter Prockdown		$I_{\rm C} = 10 \mu A$ ,	BC846	80	-	-	V	
Collector–Emitter Breakdown	V <sub>(BR)CES</sub>		BC847BPDW	50	-	-		
Voltage		V <sub>EB</sub> = 0	BC848	30	-	-		
Collector–Base Breakdown			BC846	80	-	-		
Voltage	V <sub>(BR)CBO</sub>	I <sub>C</sub> = 10μΑ	BC847	50	-	-	V	
Voltage			BC848	30	-	-		
Emitter–Base Breakdown			BC846	6.0	-	-	V	
Voltage	V <sub>(BR)EBO</sub>	I <sub>E</sub> = 1.0μA	BC847	6.0	-	-		
Voltage			BC848	5.0	-	-		
Collector Cutoff Current	Ісво	V <sub>CB</sub> = 30V		-	-	15	nA	
	ICBO	V <sub>CB</sub> = 30V, T <sub>A</sub>	-	-	5.0	μA		
ON CHARACTERISTICS								
	hfe		BC846BPDW					
		$I_{\rm C} = 2.0 {\rm mA},$	BC847BPDW	200 290 420 520	290	475	-	
DC Current Gain		$V_{CE} = 5.0V$	BC848BPDW					
		VCE - 5.0V	BC847CPDW		800			
			BC848CPDW	420	520	000		
Collector–Emitter Saturation	V <sub>CE(sat)</sub>	I <sub>C</sub> = 10mA, I <sub>В</sub>	= 0.5mA	-	-	0.25	v	
Voltage	V CL(Sal)	I <sub>C</sub> = 100mA, I		-	-	0.6	· ·	
Base–Emitter Saturation	V <sub>BE(sat)</sub>	$I_{\rm C}$ = 10mA, $I_{\rm B}$		-	0.7	-	v	
Voltage	• DE(Sat)	I <sub>C</sub> = 100mA, I <sub>I</sub>		-	0.9	-		
Base–Emitter Voltage	V <sub>BE(on)</sub>	$I_{C}$ = 2.0mA, $V_{CE}$ = 5.0V		580	660	700	mV	
		I <sub>C</sub> = 10mA, V <sub>CE</sub> = 5.0V		-	-	770		
SMALL-SIGNAL CHARACTERISTICS								
Current–Gain — Bandwidth	f⊤	Ic = 10mA, V <sub>CE</sub> = 5.0Vdc, f = 100MHz		100	-	_	MHz	
Product								
Output Capacitance	Cobo	V <sub>CB</sub> = 10 V, f = 1.0 MHz		-	-	4.5	pF	
		$I_{C} = 0.2mA, V_{CE} = 5.0Vdc,$ $R_{S} = 2.0k\Omega, f = 1.0kHz,$		-	-	10	dB	
Noise Figure	NF							
		BW = 200Hz						



# ELECTRICAL CHARACTERISTICS (PNP)

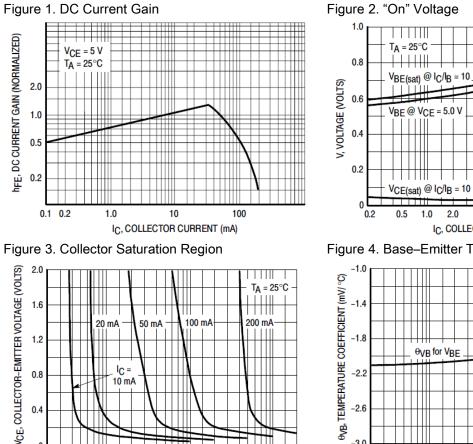
 $T_A = 25^{\circ}C$ , unless otherwise noted

Parameter	Symbol	Conditions		Min.	Тур.	Max.	Unit	
OFF CHARACTERISTICS								
			BC846	-65	-	-		
Collector–Emitter Breakdown Voltage	V <sub>(BR)CEO</sub>	Ic = -10mA	BC847	-45	-	-	V	
			BC848	-30	-	-		
		1 10 0	BC846	-80	-	-		
Collector–Emitter Breakdown	V <sub>(BR)CES</sub>	$I_{\rm C} = -10 \mu A$ ,	BC847	-50	-	-	V	
Voltage		V <sub>EB</sub> = 0	BC848	-30	-	-		
Collector Deco Drockdown			BC846	-80	-	-		
Collector–Base Breakdown	V <sub>(BR)CBO</sub>	I <sub>C</sub> = -10μΑ	BC847	-50	-	-	V	
Voltage			BC848	-30	-	-		
			BC846	-5.0	-	-		
Emitter–Base Breakdown	V(BR)EBO	I <sub>E</sub> = -1.0μΑ	BC847	-5.0	-	-	V	
Voltage			BC848	-5.0	-	-		
Collector Cutoff Current		V <sub>CB</sub> =- 30V		-	-	-15	nA	
Collector Cutoff Current	Сво	V <sub>CB</sub> = -30V, T <sub>A</sub> = 150°C		-	-	-4.0	μA	
ON CHARACTERISTICS								
DC Current Gain	h⊧⊧	$I_{C} = -10\mu A,$ $V_{CE} = -5.0V$ $I_{C} = -2.0mA,$ $V_{CE} = -5.0V$	BC846BPDW BC847BPDW BC848BPDW	-	150	-	_	
			BC847CPDW BC848CPDW	-	270	-		
			BC846BPDW BC847BPDW BC848BPDW	200	290	475	-	
			BC847CPDW BC848CPDW	420	520	800		
Collector–Emitter Saturation	V <sub>CE(sat)</sub>	I <sub>C</sub> = -10mA, I <sub>B</sub>	= -0.5mA	-	-	-0.3	V	
Voltage	V CE(sat)	I <sub>C</sub> = -100mA,	<sub>B</sub> = -5.0mA	-	-	-0.65	v	
Base–Emitter Saturation	V <sub>BE(sat)</sub>	Ic = -10mA, I <sub>B</sub>	= -0.5mA	-	-0.7	-	V	
Voltage	V DE(Sat)	I <sub>C</sub> = -100mA,	I <sub>C</sub> = -100mA, I <sub>B</sub> = -5.0mA		-0.9	-	v	
Base-Emitter Voltage	V <sub>BE(on)</sub>	,	I <sub>C</sub> = -2.0mA, V <sub>CE</sub> = -5.0V		-	-0.75	V	
		Ic = -10mA, V <sub>CE</sub> = -5.0V		-	-	-0.82	v	
SMALL-SIGNAL CHARACTERISTICS								
Current–Gain — Bandwidth Product	f⊤	$I_{C}$ = -10mA, $V_{CE}$ = -5.0Vdc, f = 100MHz		100	-	-	MHz	
Output Capacitance	Cob	V <sub>CB</sub> = -10V, f =	= 1.0 MHz	-	-	4.5	pF	
Noise Figure	NF	$I_{C}$ = -0.2mA, $V_{CE}$ = -5.0Vdc, R <sub>S</sub> = 2.0k $\Omega$ , f = 1.0kHz, BW = 200Hz		-	-	10	dB	



### **TYPICAL NPN CHARACTERISTICS**

#### **BC846**



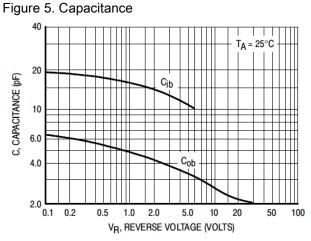
5.0 10 20

IB, BASE CURRENT (mA)

0.05 0.1 0.2

0

0.02



0.5 1.0 2.0

### Figure 2. "On" Voltage

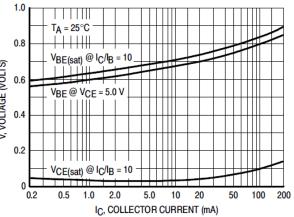


Figure 4. Base–Emitter Temperature Coefficient

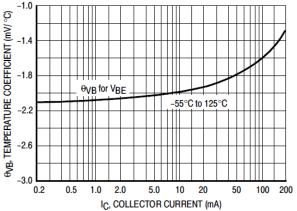
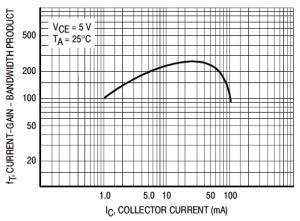


Figure 6. Current-Gain - Bandwidth Product





### TYPICAL PNP CHARACTERISTICS

#### BC846

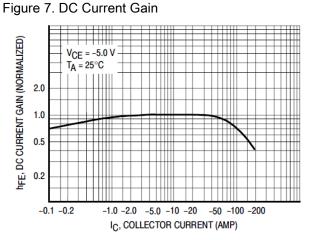


Figure 9. Collector Saturation Region

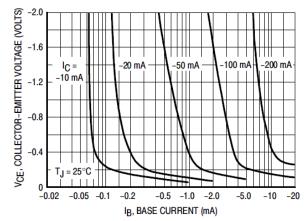


Figure 11. Capacitance

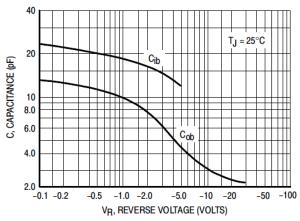


Figure 8. "On" Voltage

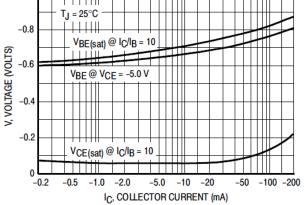


Figure 10. Base–Emitter Temperature Coefficient

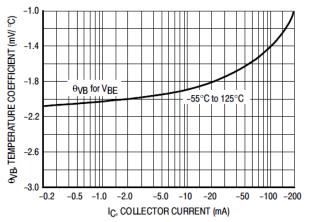
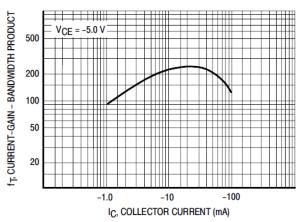


Figure 12. Current-Gain - Bandwidth Product





### TYPICAL NPN CHARACTERISTICS

#### BC847 & BC848

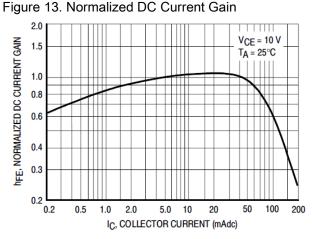


Figure 15. Collector Saturation Region

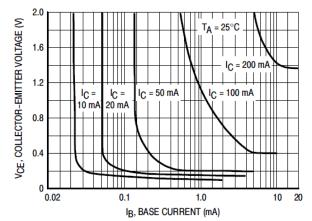
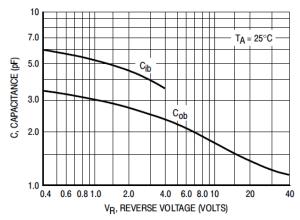


Figure 17. Capacitances



### Figure 14. "Saturation" and "On" Voltages

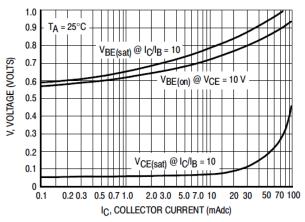


Figure 16. Base-Emitter Temperature Coefficient

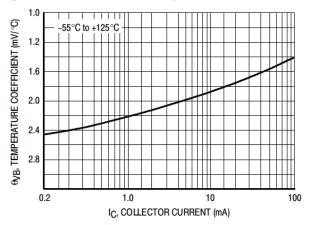
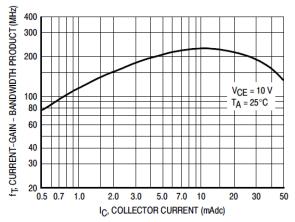


Figure 18. Current–Gain – Bandwidth Product





### TYPICAL PNP CHARACTERISTICS

#### BC847 & BC848

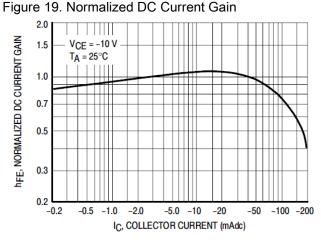


Figure 21. Collector Saturation Region

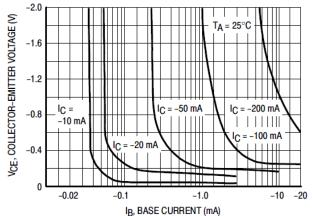


Figure 23. Capacitances

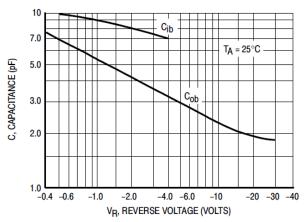


Figure 20. "Saturation" and "On" Voltages

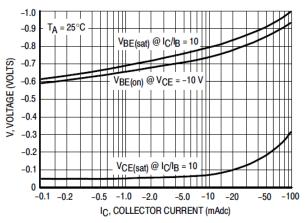


Figure 22. Base-Emitter Temperature Coefficient

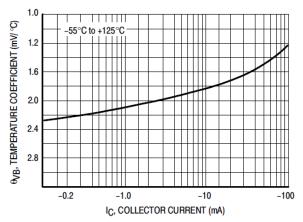
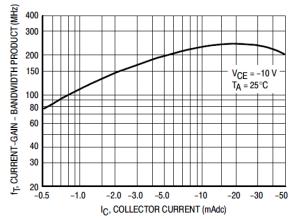


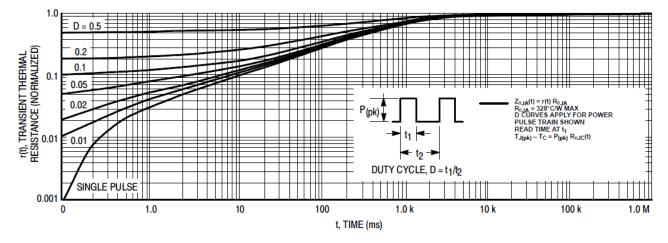
Figure 24. Current–Gain – Bandwidth Product





BC846BPDW~BC848CPDW GENERAL PURPOSE TRANSISTOR NPN/PNP DUAL (COMPLIMENTARY)

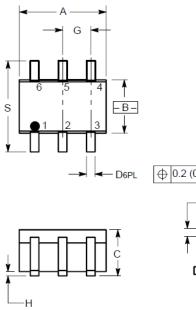
#### Figure 25. Thermal Response

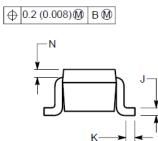


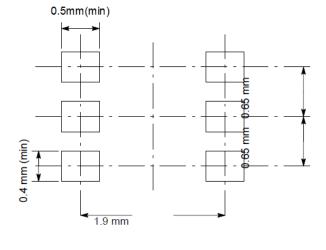


# PACKAGE INFORMATION

Dimension in SC-88 (Unit: mm)







DIM	INC	HES	MILLIMETERS		
DIM	MIN	MAX	MIN	MAX	
А	0.071	0.087	1.80	2.20	
В	0.045	0.053	1.15	1.35	
С	0.031	0.043	0.80	1.10	
D	0.004	0.012	0.10	0.30	
G	0.026 BSC		0.65 BSC		
Н	-	0.004	-	0.10	
J	0.004	0.010	0.10	0.25	
К	0.004	0.012	0.10	0.30	
N	0.008 REF		0.20	REF	
S	0.079	0.087	2.00	2.20	



### IMPORTANT NOTICE

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